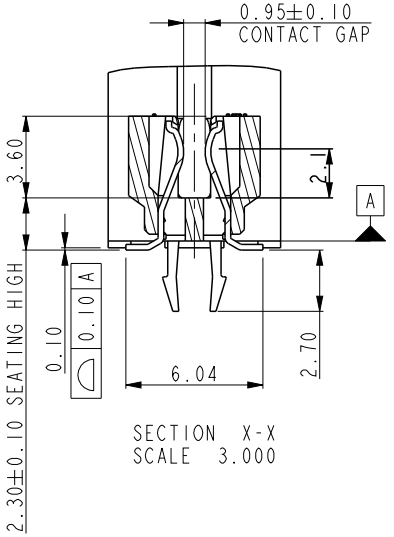
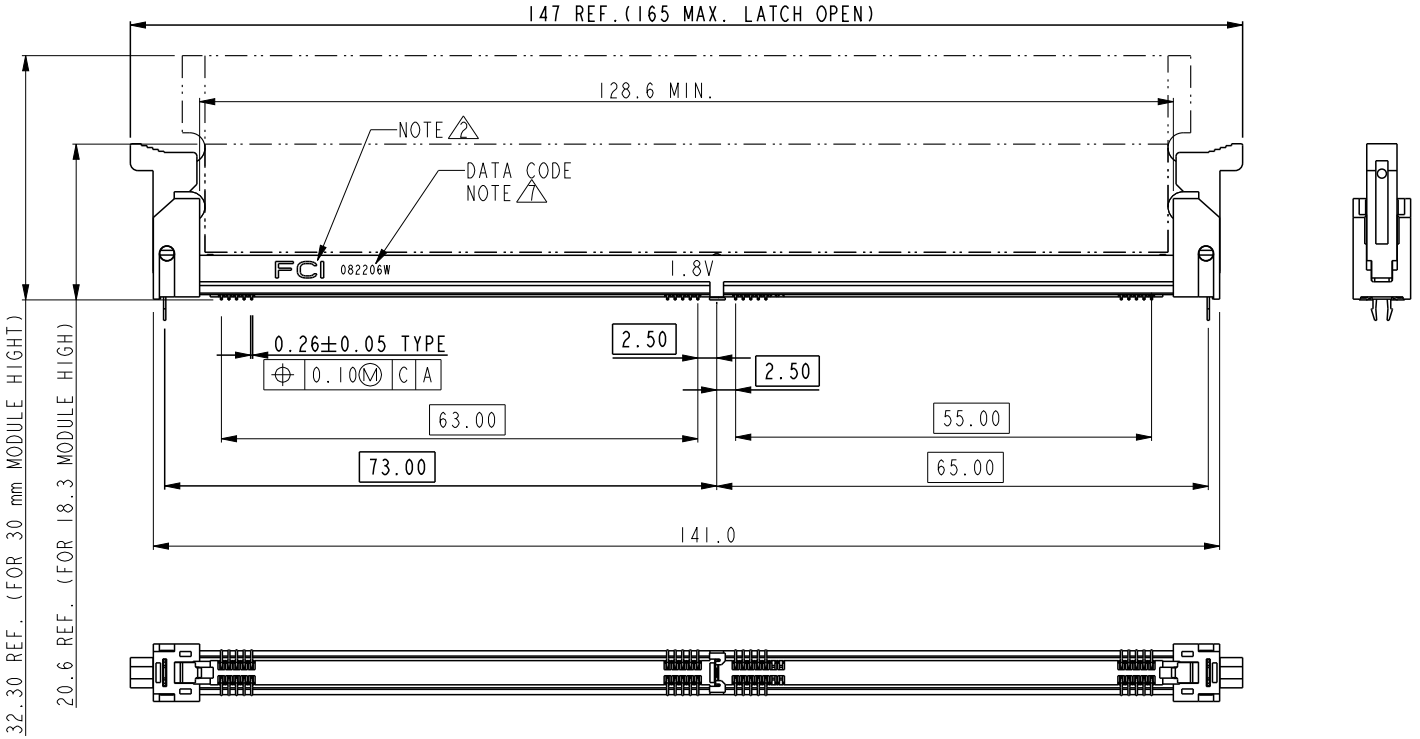




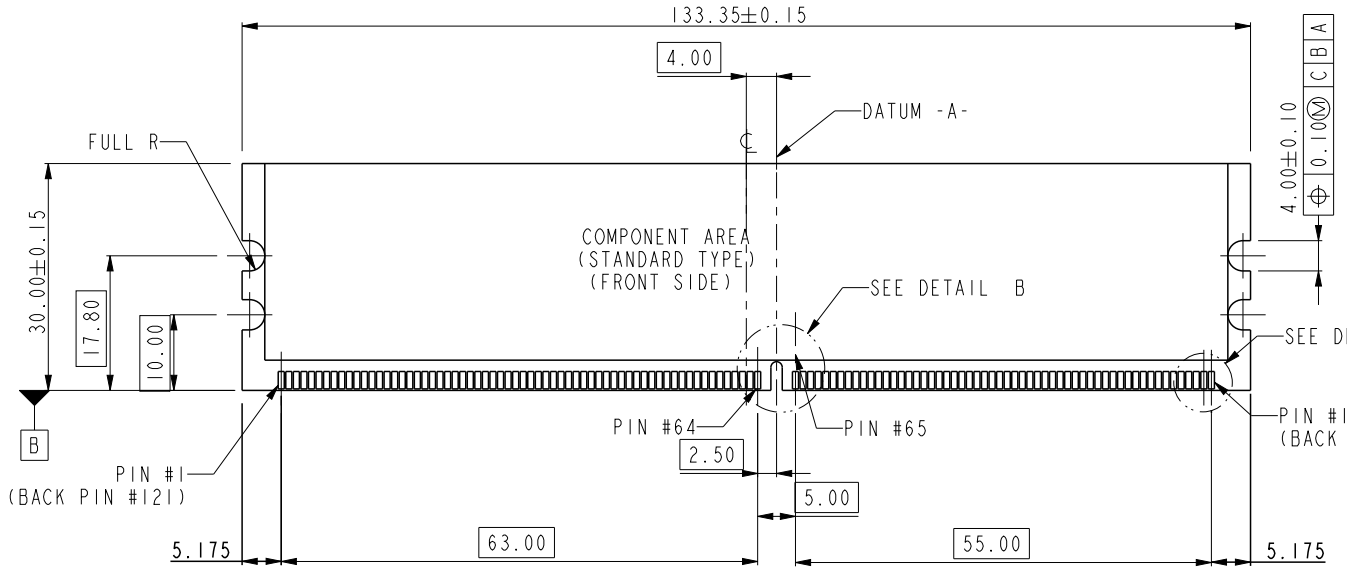


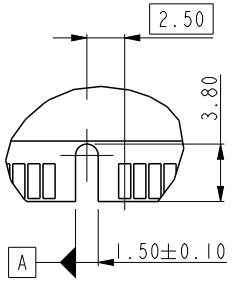
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tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED		eng	Jeny Ren	2018/01/24	size A4	scale 0.707
ISO 406 ISO 1101			chr	-	-	ecn no	ELX-DG-28708-1
			appr	Nickor Zuo	2018/01/29	product family -	rel level Released
surface -	linear	0.X	±0.15	Amphenol FCI	title	SMT TYPE DDR II ASS'Y	dwg no 10070983	rev F
ISO 1302		0.XX	±0.30			DDR II 240P		
		0.XXX	±0.5		cat. no. -	Product - Customer Drw	sheet 1 of 4	
	angular	0°	±°					

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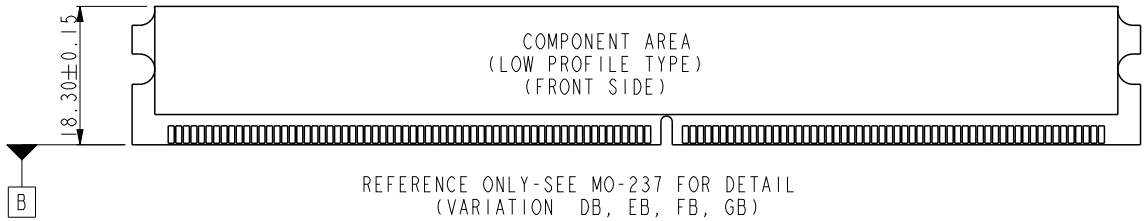
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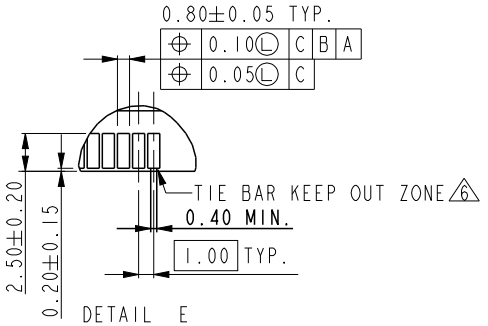




DETAIL B
SCALE 2.000



REFERENCE ONLY-SEE MO-237 FOR DETAIL
(VARIATION DB, EB, FB, GB)



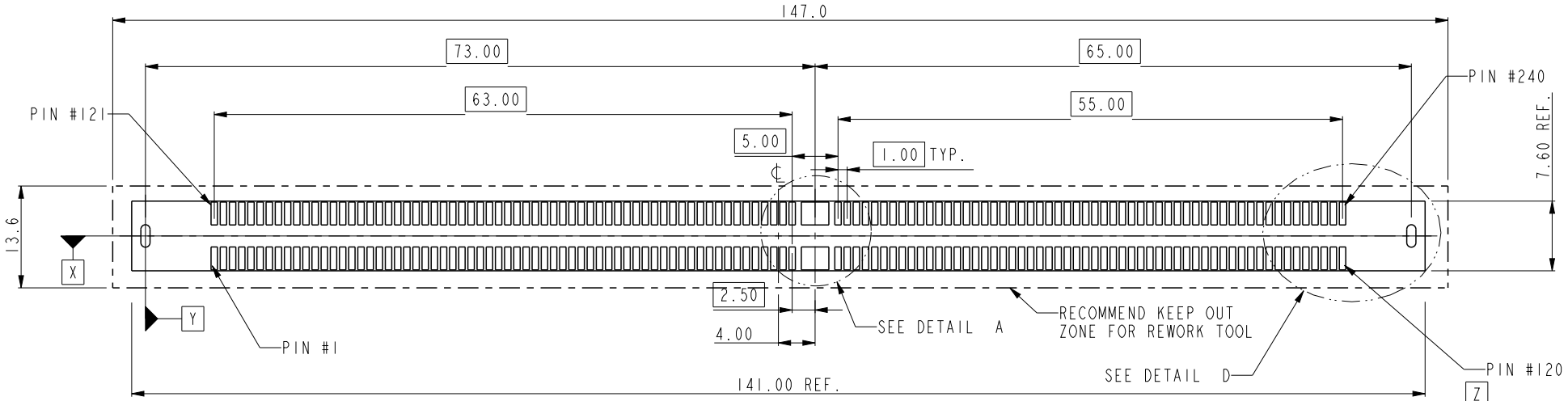
DETAIL E
SCALE 2.000

spec ref	*			dr	Rick Bian	2010/07/04	projection	MM	size A4	scale 0.500
tolerance std ISO 406 ISO 1101	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng	Jeny Ren	2018/01/24			ecn no ELX-DG-28708-1	
				chr	-	-				
				appr	Nickor Zuo	2018/01/29	product family		rel level Released	
surface ISO 1302	linear	0.X	±0.15	Amphenol FCi	title SMT TYPE DDR II ASS'Y DDR II 240P			dwg no 10070983	rev F	
		0.XX	±0.30							
		0.XXX	±0.5							
	angular	0°	±°		cat. no. *		Product - Customer Drw		sheet 2 of 4	

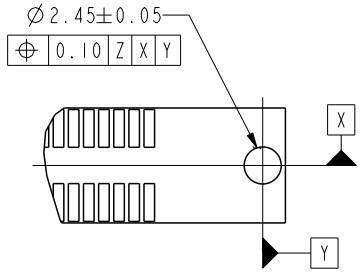
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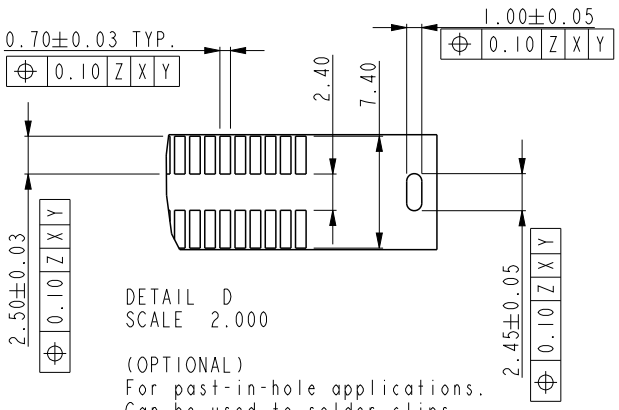


RECOMMENDED CIRCUIT BOARD LAYOUT



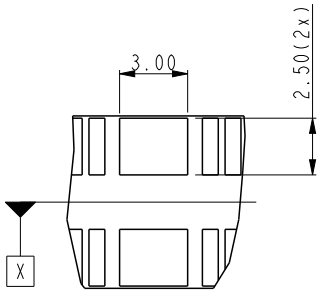
DETAIL D
SCALE 2.000

Standard hole for
hold-down clips.



DETAIL D
SCALE 2.000

(OPTIONAL)
For past-in-hole applications.
Can be used to solder clips
during reflow operation.



DETAIL A
SCALE 3.000

PCB THK±0.15 mm

spec ref	*			dr	Rick Bian	2010/07/04	projection
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng	Jeny Ren	2018/01/24	MM
ISO 406 ISO 1101				chr	-	-	size A4 / scale 0.354
				appr	Nickor Zuo	2018/01/29	ecn no ELX-DG-28708-1
							product family / rel level Released
surface	linear	0.X	±0.15	Amphenol FCi	title	SMT TYPE DDR II ASS'Y	dwg no 10070983 / rev F
ISO 1302		0.XX	±0.30			DDR II 240P	
		0.XXX	±0.5		cat. no. *	Product - Customer Drw	sheet 3 of 4
	angular	0°	±°				

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10070983 - □ □ □ □ □

PLATING

CODE	CONTACT	SOLDERTAIL	UNDERPLATE
1LF	10u" (0.25um) MIN. GOLD	100u" (2.54um) MIN. 100% MATT TIN	50u" (1.27um) MIN. NICKEL OVERALL
2LF	15u" (0.38um) MIN. GOLD		
3LF	30u" (0.76um) MIN. GOLD		
4LF	GOLD FLASH		

STYLE : MECHAMICAL KEYING

1 : 1.8 VOLT. W/ CENTER KEY

HOLD DOWN TYPE

0 : CENTER HOLD DOWN, FORK LOCK AT BOTH END

RESERVED

0

COLOR OF HOUSING AND EJECTOR

0 : BLACK HOUSING + IVORY EJECTOR

NOTES:
1. MATERIAL:
   HOUSING: HIGH PERFORMANCE RESINS, GLASS FILLED UL94V-0 RATED.
   EJECTOR: HIGH PERFORMANCE RESINS, GLASS FILLED UL94V-0 RATED.
   TERMINAL: HIGH PERFORMANCE COPPER ALLOY
   METAL CLIP: COPPER ALLOY.
2. FCI LOGO TO BE APPROXIMATELY LOCATED AS SHOWN ON PRINT.
3. PRODUCT SPECIFICATION: GS-12-481.
4. PACKAGING SPECIFICATION: GS-14-899.
5. RECOMMENDED STENCIL THICKNESS NO LESS THAN 0.15 mm.
6. FOR OPTMUM PERFORMANCE. THE TIE BAR IS TO BE ON AN INTERNAL LAYER SO THAT THE REMNANT CANNOT CAUSE CONTACT DAMAGE.
7. THE DATE CODE IS SHOWN "MM-DD-YY-W". "W" MEANS PRODUCTION LINE.
8. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
9. THE HOUSING WILL WITH STAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN AN IR REFLOW SOLDERING APPLICATION.

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spec ref	*			dr	Rick Bian	2010/07/04	projection	MM
tolerance std	TOLERANCES UNLESS OTHERWISE SPECIFIED			eng	Jeny Ren	2018/01/24		
ISO 406 ISO 1101				chr	-	-		
				appr	Nickor Zuo	2018/01/29	product family	
surface	linear	0.X	±0.15	Amphenol FCi	title	SMT TYPE DDR II ASS'Y	dwg no	10070983
		0.XX	±0.30			DDR II 240P		
ISO 1302		0.XXX	±0.5					
	angular	0°	±°		cat. no.	*	Product - Customer Drw	

size	scale	rev	
A4	0.500	F	
ecn no	ELX-DG-28708-1		
rel level	Released		
sheet 4 of 4			

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